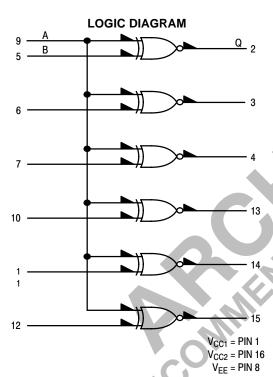
# **Hex Inverter/Buffer**

The MC10195 is a Hex Buffer Inverter which is built using six EXCLUSIVE NOR gates. There is a common input to these gates which when placed low or left open allows them to act as inverters. With the common input connected to a high logic level the MC10195 is a hex buffer, useful for high fanout clock driving and reducing stub lengths on long bus lines.

- $P_D = 200 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 2.8 \text{ ns typ (B-Q)}$
- $t_{pd} = 3.8 \text{ ns typ (A-Q)}$
- $t_r$ ,  $t_f = 2.5$  ns typ (20%–80%)



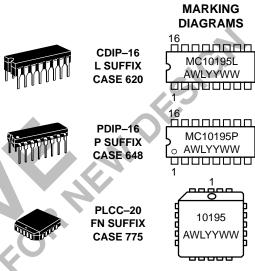
TRUTH TABLE

Inp	uts	Output
Α	В	ġ
L	Ţ	Н
L	F	L
Н	L	L
Н	Н	Н



# ON Semiconductor

http://onsemi.com



A = Assembly Location WL = Wafer Lot

YY = Year

WW = Work Week

## **DIP PIN ASSIGNMENT**

	- 1		$\neg$ $\Gamma$		ı	
V <sub>CC1</sub>		1	Ŭ	16		V <sub>CC2</sub>
Q1		2		15		Q6
Q2		3		14		Q5
Q3		4		13		Q4
В1		5		12		B6
B2		6		11		B5
В3		7		10		B4
$V_{EE}$		8		9		Α

Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

#### ORDERING INFORMATION

Device	Package	Shipping					
MC10195L	CDIP-16	25 Units / Rail					
MC10195P	PDIP-16	25 Units / Rail					
MC10195FN	PLCC-20	46 Units / Rail					

### **ELECTRICAL CHARACTERISTICS**

				Test Limits							
			Pin Under	-30	D°C		+25°C		+85	5°C	
Characte	ristic	Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply Dr	ain Current	Ι <sub>Ε</sub>	8		54		39	49		54	mAdc
Input Current		I <sub>inH</sub>	5 9		425 460			265 290		265 290	μAdc
		I <sub>inL</sub>	5	0.5		0.5			0.3		μAdc
Output Voltage	Logic 1	V <sub>OH</sub>	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	$V_{OL}$	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltag	e Logic 1	V <sub>OHA</sub>	2	-1.080		-0.980			-0.910		Vdc
Threshold Voltag	e Logic 0	$V_{OLA}$	2		-1.655			-1.630		-1.595	Vdc
Switching Times	(50Ω Load)									C	ns
Propagation Dela	ay	t <sub>5+2-</sub>	2	1.1	4.2	1.1	2.8	4.0	1.1	4.4	<i>y</i>
		t <sub>7-4+</sub>	4	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
		t <sub>10+13+</sub>	13	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
		t <sub>11-14-</sub>	14	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
		t <sub>9-14-</sub>	14	1.1	5.2	1.1	3.8	5.0	1.1	5.4	
Rise Time	(20 to 80%)	t <sub>2+</sub>	2	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Fall Time	(20 to 80%)	t <sub>2-</sub>	2	1.1	4.7	1.1	2.5	4.5	1.1	5.0	

# **ELECTRICAL CHARACTERISTICS** (continued)

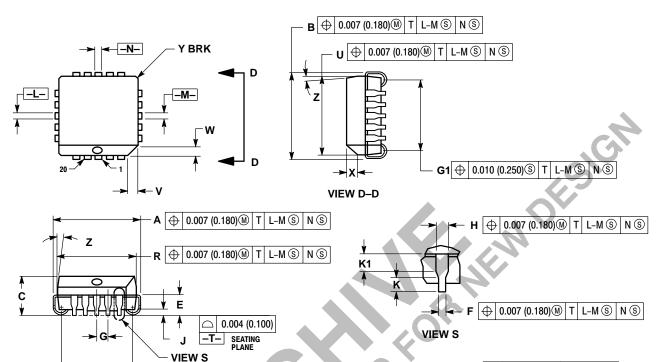
					TEST VOL	TAGE VALU	JES (Volts)		
		@ Test Te	mperature	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	
			−30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			Pin	TEST V	OLTAGE AP	PLIED TO P	INS LISTED I	BELOW	
Characteristic		Symbol	Under Test	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	(V <sub>CC</sub> ) Gnd
Power Supply Drain Curre	ent	E	8					8	1, 16
Input Current		l <sub>inH</sub>	5 9	5 9				8 8	1, 16 1, 16
		l <sub>inL</sub>	5		5			8	1, 16
Output Voltage	Logic 1	V <sub>OH</sub>	2					8	1, 16
Output Voltage	Logic 0	$V_{OL}$	2	9				8	1, 16
Threshold Voltage	Logic 1	$V_{OHA}$	2				5	8	1, 16
Threshold Voltage	Logic 0	V <sub>OLA</sub>	2			5		8	1, 16
Switching Times (	50Ω Load)					Pulse In	Pulse Out	–3.2 V	+2.0 V
Propagation Delay		t <sub>5+2</sub> - t <sub>7-4+</sub> t <sub>10+13+</sub> t <sub>11-14</sub> - t <sub>9-14</sub> -	2 4 13 14 14			5 7 10 11 9	2 4 13 14 14	8 8 8 8	1, 16 1, 16 1, 16 1, 16 1, 16
Rise Time (2	20 to 80%)	t <sub>2+</sub>	2			5	2	8	1, 16
Fall Time (2	20 to 80%)	t <sub>2-</sub>	2			5	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

#### PACKAGE DIMENSIONS

#### PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



#### NOTES:

G1 ⊕ 0.010 (0.250)③ T L-M ⑤ N ⑤

OF MICE. NOT PRESCO

- OTES:

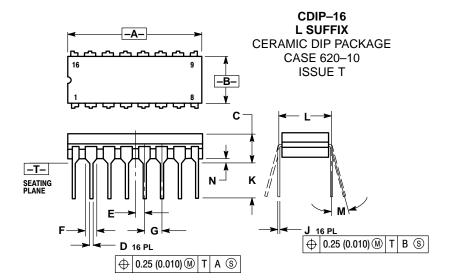
  1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

  2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

  3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

  4. DIMENSIONING AND TOLERANCING PER ANSI V14 5M 1982
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	IN O		8411 1 184	ETERO
		HES		ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Ε	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10°	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	



#### NOTES:

- ANIES.

  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

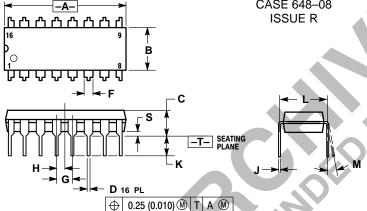
  CONTROLLING DIMENSION: INCH.

  DIMENSION L TO CENTER OF LEAD WHEN

- FORMED PARALLEL.
  DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62	BSC 4	
M	0 °	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

#### PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIM	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27	BSC	
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	
5	0.020	0.040	0.51	1.01	

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